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MARKING DIAGRAM

Small Signal BJT and MOSFET

30 V, 500 mA, PNP BJT with 20 V, 224 mA, N-Channel MOSFET

NSM3005NZ

Features

• These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

• Portable Devices

Q1 MAXIMUM RATINGS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	30	V
Collector-Base Voltage	V _{CBO}	40	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Collector Current	Ι _C	500	mA
Base Current	Ι _Β	50	mA

Q2 MAXIMUM RATINGS (T_J = 25° C unless otherwise specified)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	20	V	
Gate-to-Source Voltage		V _{GS}	±8	V	
Continuous Drain Current (Note 1)	Steady State	T _A = 25°C	I _D	224	mA
		T _A = 85°C		162	
	t ≤ 5 s	T _A = 25°C		241	
Pulsed Drain Current $T_p = 10 \ \mu s$		I _{DM}	673	mA	
Source Current (Body Diode)		۱ _S	120	mA	

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D	245 0.8	°C/W W
Operating Junction and Storage Temperature	T _J , T _{STG}	–55 to 150	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on FR4 board using 1 in sq pad size

(Cu. area = 1.127 in sq [1 oz] including traces).



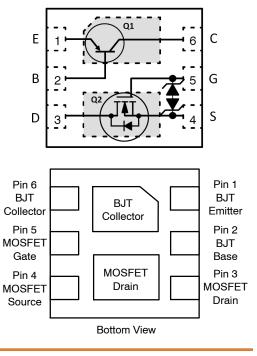


AE = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping [†]
NSM3005NZTAG	UDFN6 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Q1 ELECTRICAL CHARACTERISTICS (T,I = 25°C unless otherwise specified)

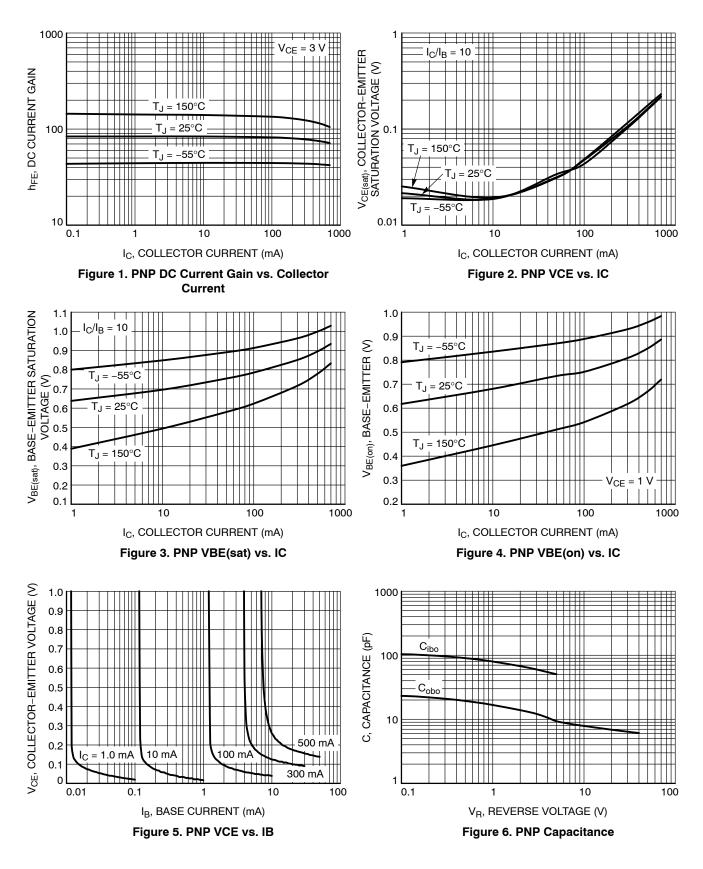
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•					
Collector-Base Breakdown Voltage	V _{(BR)CBO}	I _C = 100 μA	40	-	-	V
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C = 10 mA	30	-	-	V
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	I _E = 100 μA	5.0	-	-	V
Collector Cutoff Current	I _{CBO}	$V_{CB} = 25 \text{ V}, \text{ I}_{E} = 0 \text{ A}$	-	-	1.0	μA
Emitter Cutoff Current	I _{EBO}	$V_{EB} = 5.0 \text{ V}, I_{C} = 0 \text{ A}$	-	-	10	μA
ON CHARACTERISTICS (Note 2)						
DC Current Gain	h _{FE}	V_{CE} = 3.0 V, I_{C} = 30 mA	20	-	100	
		V_{CE} = 3.0 V, I _C = 100 mA	20	-	100	
		V_{CE} = 3.0 V, I _C = 500 mA	20	-	100	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C = 500 mA, I _B = 50 mA	-	-	0.4	V
Base-Emitter Saturation Voltage	V _{BE(sat)}	I _C = 500 mA, I _B = 50 mA	-	-	1.1	V
Base–Emitter Turn–On Voltage	V _{BE(on)}	V _{CE} = 1.0 V, I _C = 500 mA	-	-	1.0	V

Q2 ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

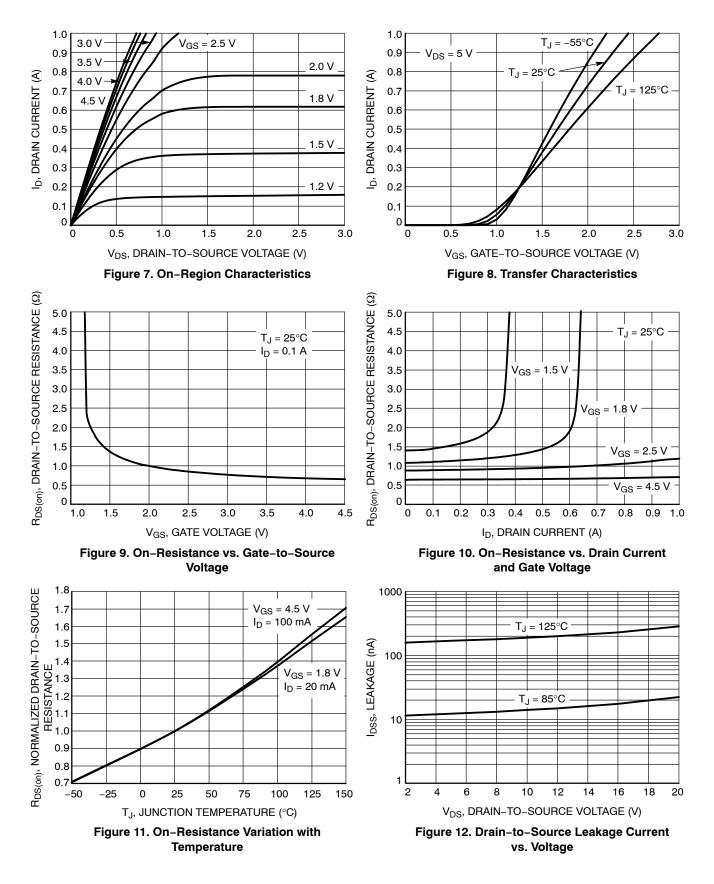
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μ A	20	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = -250 \ \mu\text{A}$, ref to 25°C	-	19	-	mV/°C
Zero Gate Votlage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 16 V, T_J = 25°C	_	-	1.0	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±8.0 V	_	-	±2.0	μA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	0.4	-	1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	-	_	1.9	-	mV/°C
Drain-to-Source On Resistance	R _{DS(ON)}	V_{GS} = 4.5 V, I _D = 100 mA	_	0.65	1.4	Ω
		V_{GS} = 2.5 V, I _D = 50 mA	_	0.9	1.9	-
		V _{GS} = 1.8 V, I _D = 20 mA	_	1.1	2.2	
		V _{GS} = 1.5 V, I _D = 10 mA		1.4	4.3	
Forward Transconductance	9 FS	$V_{DS} = 5.0 \text{ V}, \text{ I}_{D} = 100 \text{ mA}$	_	0.56	-	S
CHARGES AND CAPACITANCES						
Input Capacitance	C _{ISS}	f = 1.0 MHz, V _{GS} = 0 V,	_	15.8	-	pF
Output Capacitance	C _{OSS}	V _{DS} = 15 V	-	3.5	-	
Reverse Transfer Capacitance	C _{RSS}		_	2.4	-	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V;	-	0.70	-	nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 200 mA	_	0.05	-	
Gate-to-Source Charge	Q _{GS}		-	0.14	-	
Gate-to-Drain Charge	Q_{GD}		-	0.10	-	
SWITCHING CHARACTERISTICS, V_{GS} = 4.5	V (Note 3)					
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DD} = 15 V, I_{D} = 200 mA, R_{G} = 2 Ω	-	18	-	ns
Rise Time	t _r		_	35	-	
Turn-Off Delay Time	T _{d(ON)}		-	201	-	
Fall Time	t _f		-	110	-	
DRAIN-SOURCE DIODE CHARACTERISTIC	s					
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 mA	_	0.55	1.0	V

Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

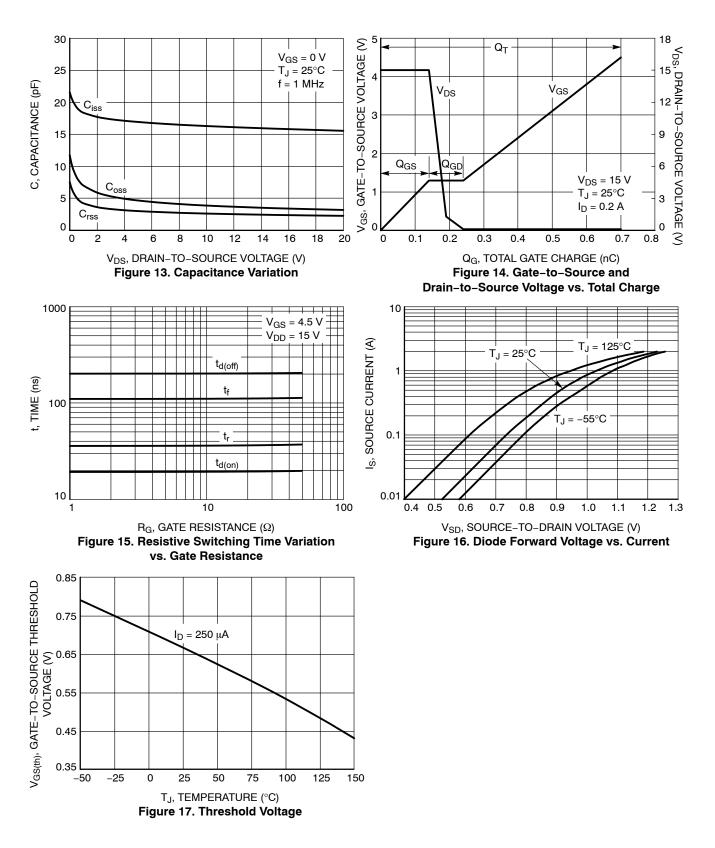
TYPICAL CHARACTERISTICS – Q1



TYPICAL CHARACTERISTICS – Q2

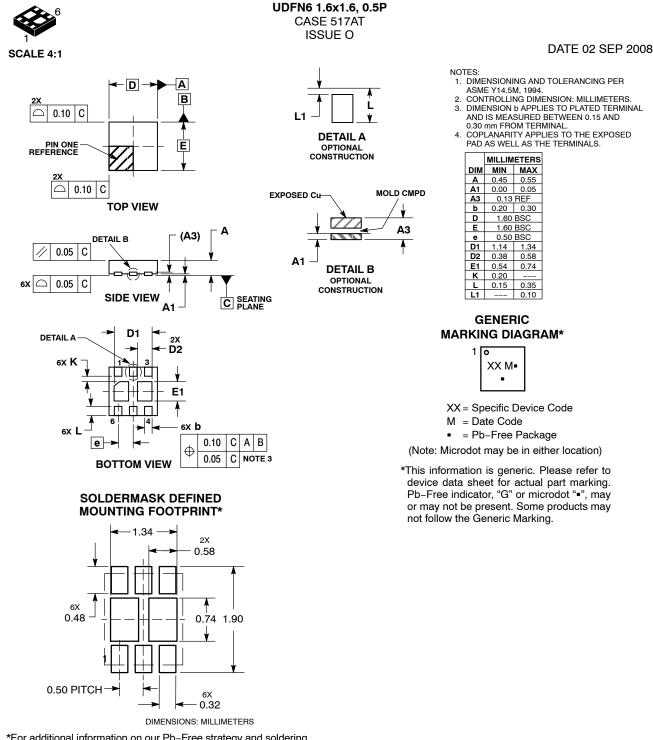


TYPICAL CHARACTERISTICS – Q2



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*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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